

SILENT TECHNOLOGIES, INC.
Department, DL429
Intellectual Property Administration
P. O. Box 7599
Loveland, Colorado 80537-0599

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PATENT APPLICATION

ATTORNEY DOCKET NO. 10003797-1

2833

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Bob J. Self et al

Serial No.: 09/836753

Examiner: Edwin A. Leon

Filing Date: Apr 17, 2001

Group Art Unit: 2833

Title: Solder-Down Printed Circuit Board Connection Structure

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

TRANSMITTAL LETTER FOR RESPONSE/AMENDMENT

RECEIVED
JUN 11 2002
TECHNOLOGY CENTER 2800

Sir:

Transmitted herewith is/are the following in the above-identified application:

- (X) Response/Amendment (X) Petition to extend time to respond
(X) New fee as calculated below () Supplemental Declaration
() No additional fee (Address envelope to "Box Non-Fee Amendments")
() Other: (fee \$)

| CLAIMS AS AMENDED BY OTHER THAN A SMALL ENTITY | | | | | | |
|--|--|------------------------|--|-------------------------|-------------|---------------------------|
| (1) FOR | (2) CLAIMS REMAINING AFTER AMENDMENT | (3) NUMBER EXTRA | (4) HIGHEST NUMBER PREVIOUSLY PAID FOR | (5) PRESENT EXTRA | (6) RATE | (7) ADDITIONAL FEES |
| TOTAL CLAIMS | 15 | MINUS | 30 | = 0 | X \$18 | \$ 0 |
| INDEP. CLAIMS | 1 | MINUS | 3 | = 0 | X \$84 | \$ 0 |
| [] FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM | | | | | + \$280 | \$ 0 |
| EXTENSION FEE | 1ST MONTH \$110.00 | 2ND MONTH \$400.00 | 3RD MONTH \$920.00 | 4TH MONTH \$1440.00 | | \$ 110 |
| | X | | | | | |
| OTHER FEES | | | | | | \$ |
| TOTAL ADDITIONAL FEE FOR THIS AMENDMENT | | | | | | \$ 110 |

Charge \$ 110 to Deposit Account 50-1078. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 50-1078 pursuant to 37 CFR 1.25. Additionally please charge any fees to Deposit Account 50-1078 under 37 CFR 1.16, 1.17, 1.19, 1.20 and 1.21. A duplicate copy of this sheet is enclosed.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231.

Date of Deposit: 5/15/02

Typed Name: Sue A. Hebert

Signature: Sue A. Hebert

Respectfully submitted,

Bob J. Self et al

By

Kyle J Way

Attorney/Agent for Applicant(s)
Reg. No. 45,549

Date: 5/15/02